



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

SBE002 — Schottky Barrier Diode 50V, 1A Rectifier

Applications

- High frequency rectification (switching regulators, converters, choppers)

Features

- Low forward voltage (V_F max=0.55V)
- Fast reverse recovery time (t_{rr} max=10ns)
- Low switching noise
- Low leakage current and high reliability due to highly reliable planar structure
- Ultrasmall package, permitting SBE002-applied sets to be compact and slim (mounting height 0.9mm)
- Large allowable power dissipation

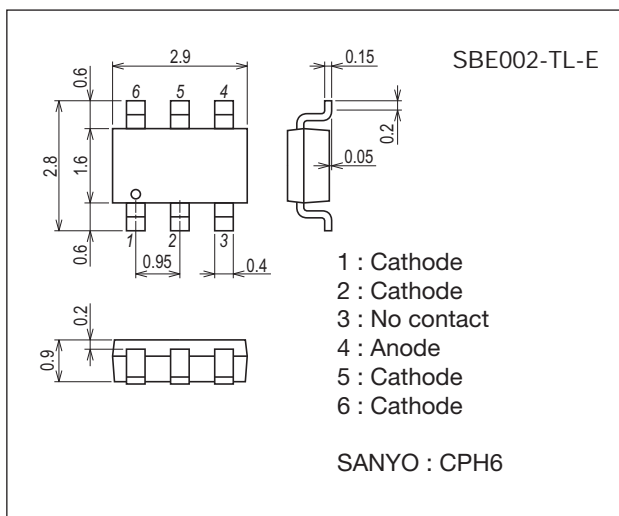
Specifications

Absolute Maximum Ratings at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Repetitive Peak Reverse Voltage	V_{RRM}		50	V
Nonrepetitive Peak Reverse Surge Voltage	V_{RSM}		55	V
Average Output Current	I_O		1	A
Surge Forward Current	I_{FSM}	50Hz sine wave, 1 cycle	10	A
Junction Temperature	T_j		-55 to +125	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +125	$^\circ\text{C}$

Package Dimensions

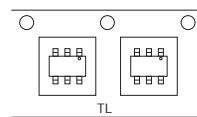
unit : mm (typ)
7018A-012



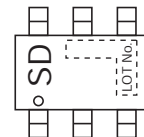
Product & Package Information

- Package : CPH6
- JEITA, JEDEC : SC-74, SOT-26, SOT-457
- Minimum Packing Quantity : 3,000 pcs./reel

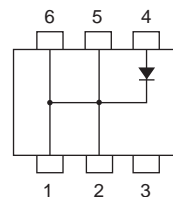
Packing Type: TL



Marking



Electrical Connection

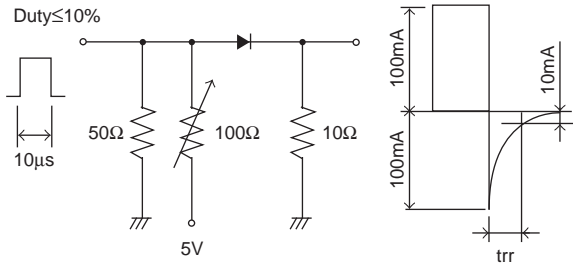


SBE002

Electrical Characteristics at $T_a=25^{\circ}\text{C}$

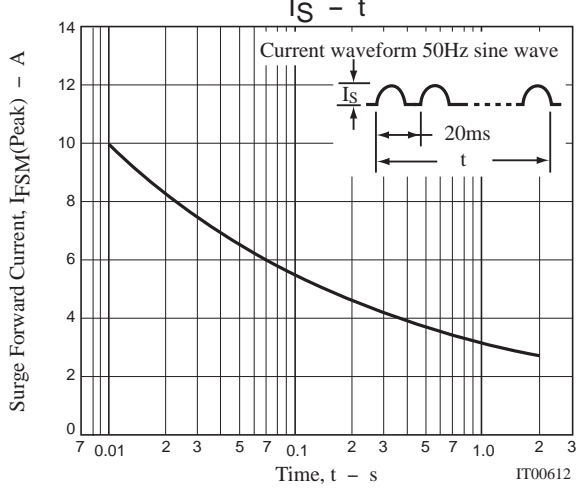
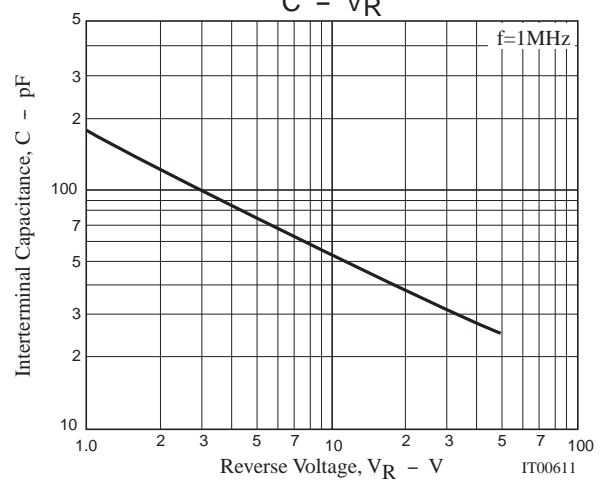
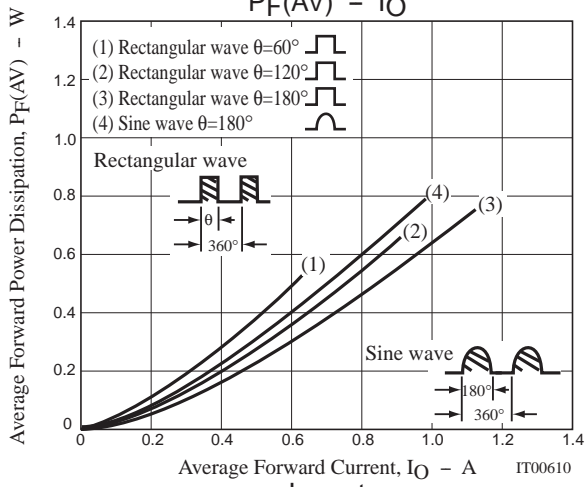
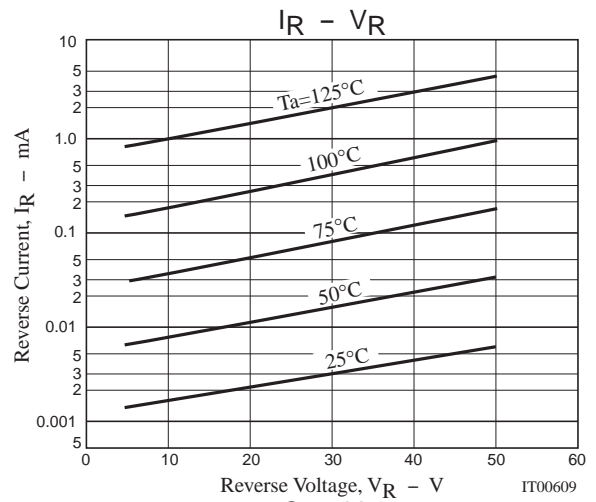
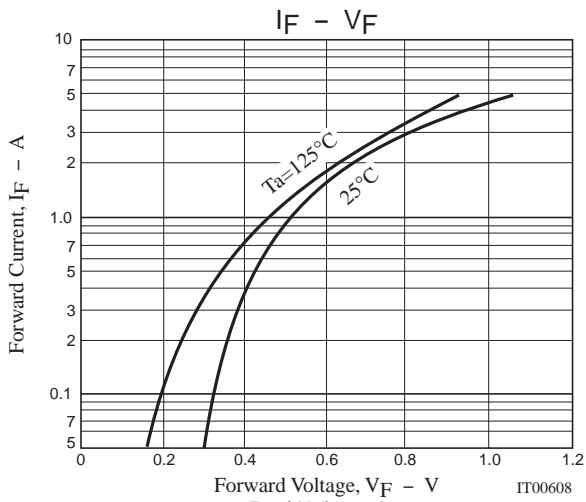
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Reverse Voltage	V_R	$I_R=300\mu\text{A}$	50			V
Forward Voltage	V_F	$I_F=1\text{A}$			0.55	V
Reverse Current	I_R	$V_R=25\text{V}$			80	μA
Interterminal Capacitance	C	$V_R=10\text{V}$, $f=1\text{MHz}$		52		pF
Reverse Recovery Time	t_{rr}	$I_F=I_R=100\text{mA}$, See specified Test Circuit.			10	ns
Thermal Resistance	$R_{th(j-a)}$	When mounted on ceramic substrate (600mm ² ×0.8mm)		110		$^{\circ}\text{C} / \text{W}$

t_{rr} Test Circuit



Ordering Information

Device	Package	Shipping	memo
SBE002-TL-E	CPH6	3,000pcs./reel	Pb Free



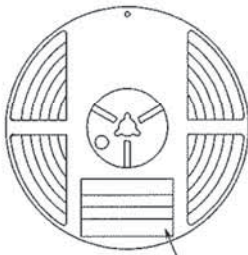
Embossed Taping Specification

SBE002-TL-E

1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
CPH6	CPH6	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method

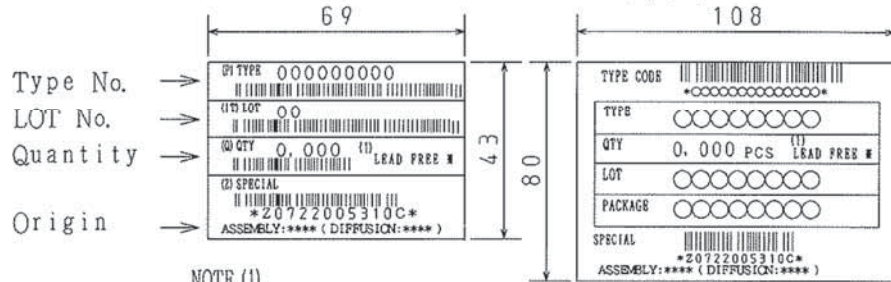


Reel label

Reel label, Inner box label
(unit:mm)

Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.



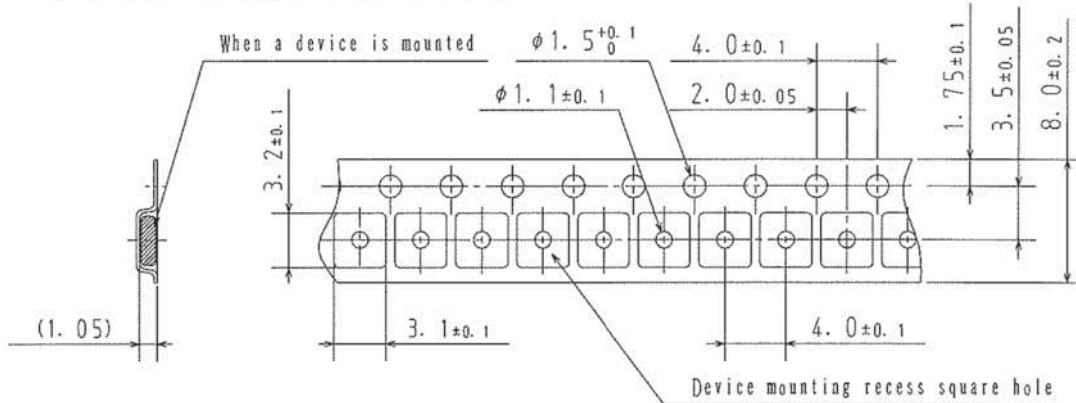
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

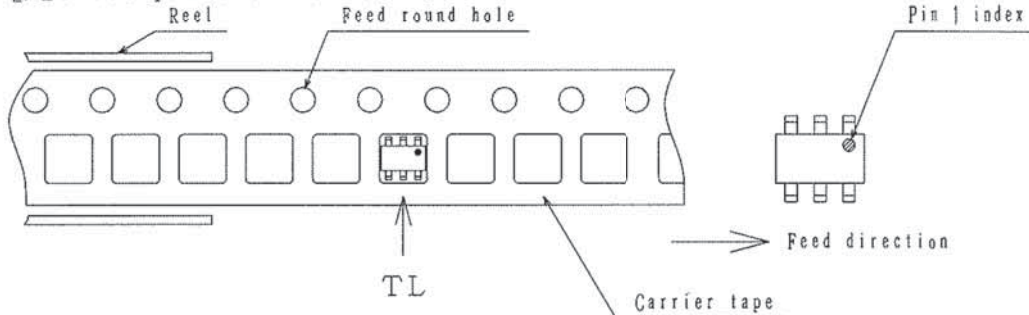
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



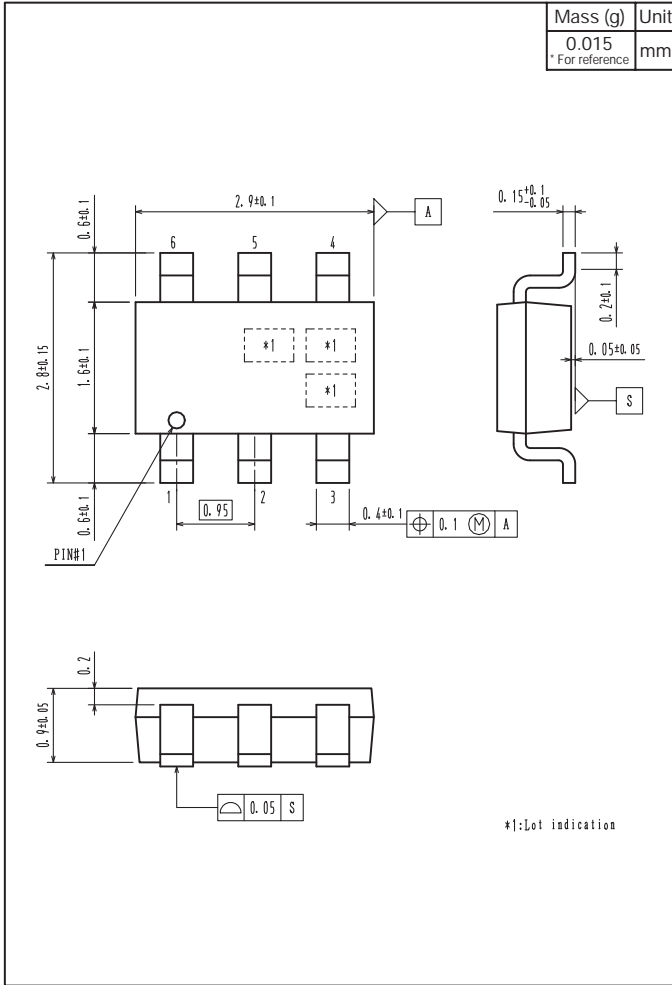
2-2. Device placement direction



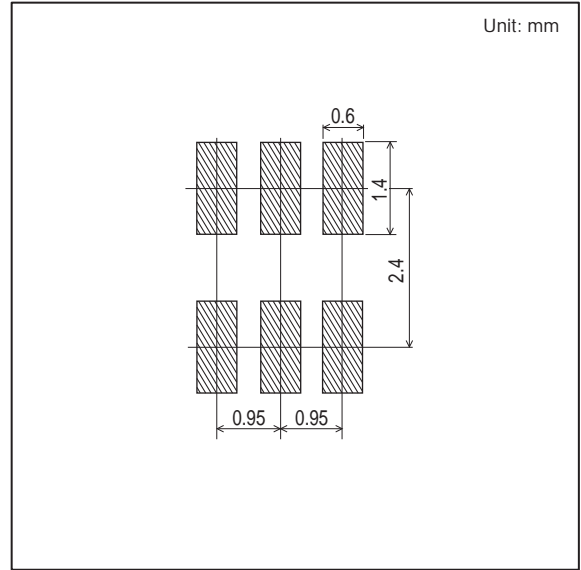
Those with pin 1 index on the feed hole side.....TL

Outline Drawing

SBE002-TL-E



Land Pattern Example



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